- 1. 若材料產生塑性變形時,其應力與應變關係為 $\sigma = k \cdot \epsilon^n (k : 強度係數; n : 硬度硬化指數),試證明 necking 產生時,<math>n = \epsilon_t (\epsilon_t : 真應變) \cdot (10\%)$
- 2. 請說明析出強化的三步驟及其強化理論。(15%)
- 3. 材料爲消除因冷加工所造成之硬化而做退火處理,試說明三階段之組織變化,並比較三階段之晶粒大小、抗拉強度與伸長率。(15%)
- 4. 比較熱作加工與冷作加工之區別,又如 Fe、Pb 的常溫加工是屬於冷作還是 熱作。(10%)
- 5. 金屬材料、陶瓷材料、聚合物材料之特性各有何不同之處 (10%)
- 6. 試請繪出 AISI 1045 中碳鋼退火後之拉伸試驗曲線,並標出各特徵點。又如何由曲線中求取或定義降服強度?又對鑄鐵材料或調質鉻鉬鋼(SCM439)材料如何求取或定義降服強度?(20%)
- 7. 閱讀下列三段小文章,用中文精確寫出意思,劃底線字請解釋
  - are demanding ever more stringent controls over particle contamination on semiconductor <u>wafers</u> during their processing. Consequently, there is a need for objective inspection techniques to monitor defects and contaminants on the surface of semiconductor devices. (7%)

♦ The decreasing geometries and increasing die sizes of today's VLSI circuits

- ♦ It is found that during the deformation process, while the <u>dislocation</u> density increases monotonically, the average fluctuation exhibits a maximum corresponding to work hardening(7%)
- ♦ Analysis of the stress-strain characteristics and X-Ray diffraction results reveal that the <u>fracture toughness</u> of the specimens can not be simply attributed to the phase transformation (6%)